

1 Description

The iW9801 is a high-performance AC/DC primary-side digital flyback controller with advanced zero-voltage-switching (ZVS) and adaptive multi-mode-control (MMC) working with secondary-side regulation (SSR) for applications requiring high power density and high resolution in output voltage/current setting. The device can support rapid charge applications such as travel adapters (TA) of 25W and above. It operates under multi-mode control (MMC) including PWM, PFM and burst mode with main switch ZVS turn-on at high line voltage to achieve less switching loss and low EMI. It also provides a number of key built-in protection features.

The iW9801 is optimized to work with Dialog's secondary-side controller, the iW70x, for SSR, synchronous rectifier (SR) control and USB PD 3.0 with PPS protocol support. The iW9801/iW70x chipset can achieve tight multi-level constant voltage (CV) and multi-level constant current (CC) regulation in very fine steps for rapid charge applications. With SSR digital compensation, the chipset eliminates the need for external loop compensation components while maintaining stability under all operating conditions.

The iW9801 and iW70x chipset can support USB PD 3.0 with PPS to achieve fast and smooth CV/CC transitions upon request by mobile devices (MD). The iW9801 and iW70x chipset can meet no-load power consumption of less than 20mW for a typical 25W to 45W design when the output USB cable is detached.

Dialog's innovative proprietary technology ensures that power supplies designed with the iW9801 and iW70x chipset can achieve high efficiency, high accuracy voltage/current control and fast dynamic load response.

2 Features

- Supports USB PD travel adapter (TA) applications of 35W and above
- Supports constant-voltage (CV) and constant-current (CC) regulation in fine steps by secondary-side regulation (SSR)
- Dialog's patented adaptive ZVS control enables high efficiency and low EMI
- User configurable ZVS timing to optimize performance for different power devices
- Adaptive multi-mode control (MMC) using PWM/ PFM/Burst modes based on input voltage and output voltage/current improves efficiency and eliminates audible noise

- Built-in single-point fault protections against AC line voltage brown-out, output short-circuit, output overvoltage, and optocoupler failure
- Optional user programable internal over-temperature protection (OTP) threshold for various thermal requirement
- < 20mW no load standby power for typical 25W to 45W designs at 230V_{AC} when output USB cable is detached
- AC unplug detection and X-capacitor discharge control
- 10-lead SOIC package

3 Applications

 Rapid-charging AC/DC adapters for smart phones, tablets and other portable devices



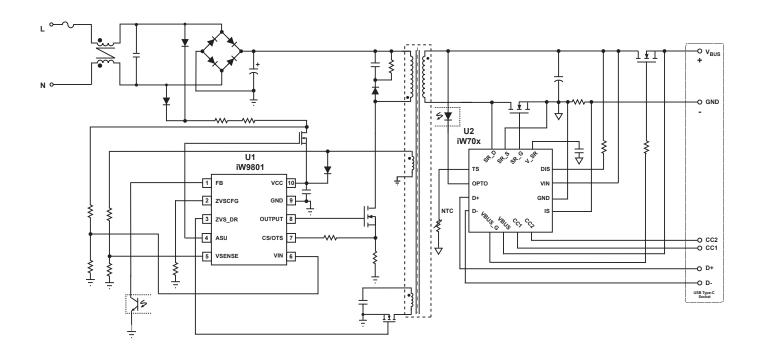


Figure 3.1 : iW9801 Typical Application Circuit with Active Start-up Circuit (Using iW70x as Secondary-Side Controller. Achieving Multi-Level CV/CC Regulation)



4 Pinout Description

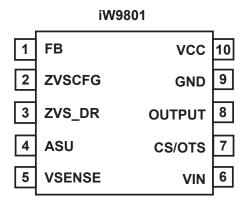


Figure 4.1: 10-Lead SOIC Package

Pin Number	Pin Name	Туре	Pin Description
1	FB	Analog Input	Feedback voltage. Used for determining multi-mode control and cycle-by-cycle peak current control.
2	ZVSCFG	Analog Input	ZVS timing configuration. Used for fine-tuning of ZVS auxiliary switch turn-on time.
3	ZVS_DR	Analog Output	Gate drive for auxiliary switch for ZVS purpose.
4	ASU	Analog Output	Control Signal. Used for active start-up device (BJT or depletion mode N-FET).
5	VSENSE	Analog Intput	Voltage sensing. Used for output voltage sensing and auxiliary winding ringing voltage sensing.
6	VIN	Analog Intput	Input AC line voltage detection. Used for AC line voltage detection and AC unplug detection for X-capacitor discharge.
7	CS/OTS	Analog Input	Current sensing. Used for cycle-by-cycle peak-current control and limit. During configuration stage, it can be used to configure certain parameters, such as internal over-temperature protection setting.
8	OUTPUT	Analog Output	Gate drive for main power switch.
9	GND	Ground	Ground.
10	VCC	Power Input	IC power supply.



5 Absolute Maximum Ratings

Absolute maximum ratings are the parameter values or ranges which can cause permanent damage if exceeded. For maximum safe operating conditions, refer to Electrical Characteristics in Section 6.

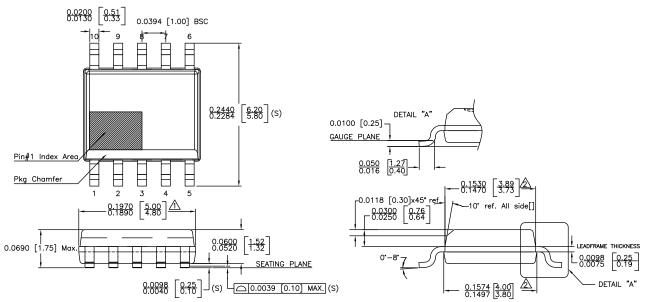
Parameter	Symbol	Value	Units
DC supply voltage range	V _{VCC}	-0.3 to 45	V
Continuous DC supply current at VCC pin (V _{VCC} = 15V)	I _{vcc}	20	mA
VSENSE input (I _{VSENSE} ≤ 10mA)		-0.7 to 10	V
FB voltage		-0.3 to 5.0	V
ZVSCFG voltage		-0.3 to 5.5	V
ZVS_DR voltage		-0.3 to 20	V
VIN voltage		-0.3 to 5.0	V
ASU voltage		-0.3 to 45	V
CS/OTS voltage		-0.3 to 5.5	V
OUTPUT voltage		-0.3 to 20	V
Maximum junction temperature	T _{JMAX}	150	°C
Operating junction temperature	T _{JOPT}	-40 to 150	°C
Storage temperature	T _{STO}	-65 to 150	°C
Thermal Resistance Junction-to-Ambient	θ_{JA}	160	°C/W
ESD rating per JEDEC JS-001-2017		±2,000	V
Latch-up test per JESD78E		±100	mA

Notes:

Note 1. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, so functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



6 Physical Dimensions



NOTE:

- ⚠ DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

 MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL NOT

 EXCEED .006 INCH PER SIDE.
- DOES NOT INCLUDE INTER-LEAD FLASH OR PROTRUSIONS.

 INTER-LEAD FLASH AND PROTRUSIONS SHALL NOT

 EXCEED .010 INCH PER SIDE.

 3. PACKAGE DIMENSION CONFORM TO JEDEC SPECIFICATION MS-012 EXCEPT
- LEAD PITCH.
- 4. LEAD SPAN/STAND OFF HEIGHT/COPLANARITY ARE CONSIDERED AS SPECIAL CHARACTERISTIC.(S)
- 5. CONTROLLING DIMENSIONS IN INCHES.[mm]
- 6. PHYSICAL APPEARANCE OF PACKAGE (E-PIN, DIMPLE, CHAMFER) MAY VARY DUE TO ASSEMBLY TOOLINGS

STATU	S:					
RELEA	SED					
TERMINAL FINISH:						
PPF or 100% Sn						
TITLE:						
SOP	IOL 150MIL PACKAGE OUTLINE					
REV:	REVISION NOTE:					
С	STANDARDIZED POD					

Figure 7.1: 10-Lead SOIC Package Outline Drawing (For pin 1 identifier and top marking information, please see section 12)

7 Ordering Information

Part no.	Options									
	V _{BUS} range	ССМ	zvs	F _{SW(MAX)} at low line	F _{SW(MAX)} at high line	V _{BUS} / V _{SENSE}	X-cap discharge	Internal OTP	Package	Description
iW9801-00	3.3V to 21V	No	Yes at high line	100kHz	95kHz	5:0.7	Yes	Yes	SOIC-10	Tape & Reel¹
iW9801-06	3.3V to 21V	Yes	Yes at high line	110kHz	95kHz	5:0.7	Yes	Yes	SOIC-10	Tape & Reel ¹
iW9801-07	3.3V to 21V	No	Yes at high line	140kHz	130kHz	5:0.7	Yes	Yes	SOIC-10	Tape & Reel ¹
iW9801-20	3.3V to 21V	No	Yes at high line	100kHz	95kHz	5:0.7	Yes	No	SOIC-10	Tape & Reel ¹

Note 1: Tape & Reel packing quantity is 2,500/reel. Minimum packing quantity is 2,500.

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8 Top Marking

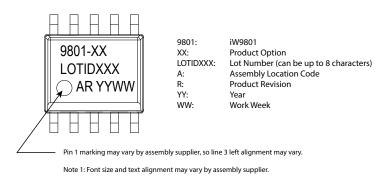


Figure 8.1 : Top Marking for the iW9801 (SOIC-10)



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